

# **1.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER**

PowerDI<sup>®</sup>123

**DFLS1200** 

## **Features**

- Guard Ring Die Construction for Transient Protection ٠
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead Free Finish, RoHS Compliant (Note 4)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: PowerDI<sup>®</sup>123 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- **Terminal Connections: Cathode Band**
- Terminals: Finish Matte Tin annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

## **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value			
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	141	V		
Average Forward Current	I <sub>F(AV)</sub>	1.0	A		
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	40	A		

## Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit		
Thermal Resistance Junction to Ambient (Note 1)	R <sub>θJA</sub>	132		°C/W		
Thermal Resistance Junction to Soldering Point (Note 2)	R <sub>0JS</sub>	_	7	°C/W		
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +175				

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	V <sub>(BR)R</sub>	200	_	_	V	$I_R = 8\mu A$
Forward Voltage	VF	_	_	0.85	V	I <sub>F</sub> = 1.0A
Leakage Current (Note 3)	I <sub>R</sub>	_		2	μΑ	$V_R = 200V, T_A = 25^{\circ}C$
Total Capacitance	CT		23		рF	$V_R = 5VDC, f = 1MHz$

Notes: 1. Part mounted on FR-4 board with 2 oz., minimum recommended copper pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. T<sub>A</sub> = 25°C

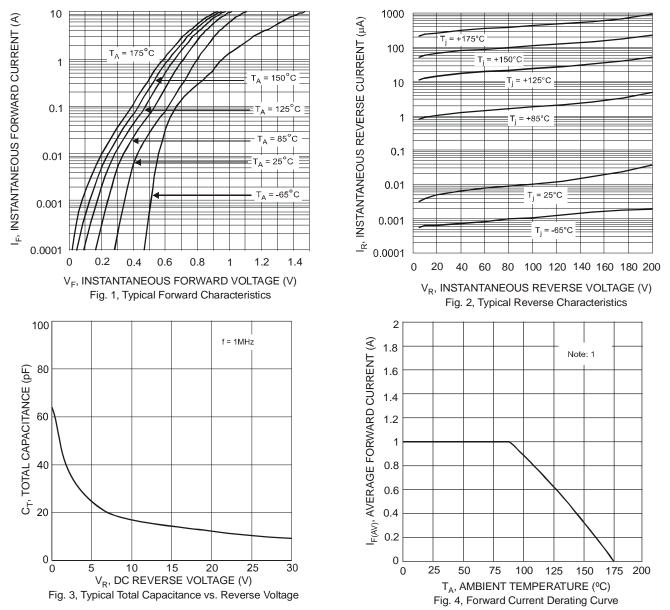
2. Theoretical R<sub>MJS</sub> calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

3. Short duration pulse test used to minimize self-heating effect.

4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.



## **DFLS1200**



## Ordering Information (Note 5)

Part Number	Case	Packaging
DFLS1200-7	PowerDI <sup>®</sup> 123	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

<b>F08</b>	ΥM	

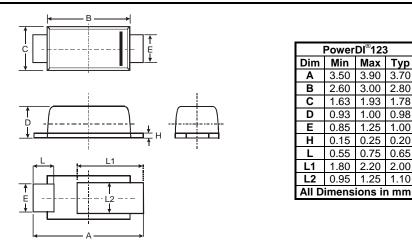
F08 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: R = 2004) M = Month (ex: 9 = September)

Date Code Key												
Year	2004	20	005	2006	2007	20	08	2009	2010	20	)11	2012
Code	R		S	Т	U	N	/	W	Х		Y	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

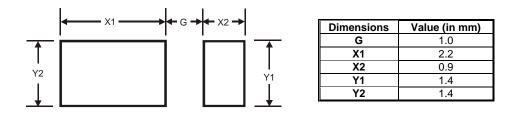
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#### **Package Outline Dimensions**



## **Suggested Pad Layout**



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